

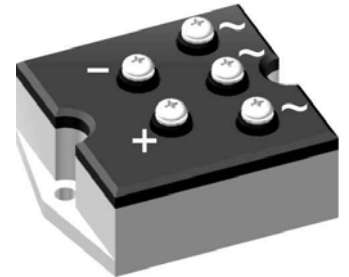
# Standard Rectifier Module

<b>3~ Rectifier</b>	
$V_{RRM}$	= 1600 V
$I_{DAV}$	= 60 A
$I_{FSM}$	= 750 A

## 3~ Rectifier Bridge

Part number

**VUO55-16N07**



E72873



### Features / Advantages:

- Package with DCB ceramic
- Improved temperature and power cycling
- Planar passivated chips
- Very low forward voltage drop
- Very low leakage current

### Applications:

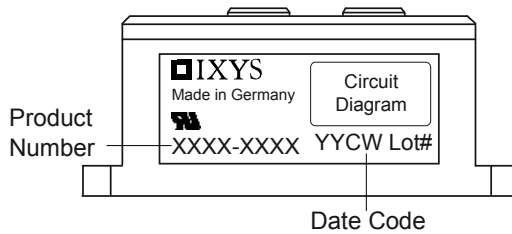
- Diode for main rectification
- For three phase bridge configurations
- Supplies for DC power equipment
- Input rectifiers for PWM inverter
- Battery DC power supplies
- Field supply for DC motors

### Package: PWS-B

- Industry standard outline
- RoHS compliant
- Easy to mount with two screws
- Base plate: Aluminium internally DCB isolated
- Advanced power cycling

Rectifier				Ratings			
Symbol	Definition	Conditions		min.	typ.	max.	Unit
$V_{RSM}$	max. non-repetitive reverse blocking voltage					1700	V
$V_{RRM}$	max. repetitive reverse blocking voltage					1600	V
$I_R$	reverse current	$V_R = 1600$ V	$T_{VJ} = 25^\circ\text{C}$			100	$\mu\text{A}$
		$V_R = 1600$ V	$T_{VJ} = 150^\circ\text{C}$			1.5	mA
$V_F$	forward voltage drop	$I_F = 20$ A	$T_{VJ} = 25^\circ\text{C}$			1.03	V
				$I_F = 60$ A			1.23
		$I_F = 20$ A	$T_{VJ} = 125^\circ\text{C}$				0.92
				$I_F = 60$ A			1.18
$I_{DAV}$	bridge output current	$T_C = 85^\circ\text{C}$ rectangular $d = \frac{1}{3}$	$T_{VJ} = 150^\circ\text{C}$				60
$V_{FO}$	threshold voltage			$T_{VJ} = 150^\circ\text{C}$		0.76	V
$r_F$	slope resistance						6.9
$R_{thJC}$	thermal resistance junction to case					2.7	K/W
$R_{thCH}$	thermal resistance case to heatsink				0.4		K/W
$P_{tot}$	total power dissipation			$T_C = 25^\circ\text{C}$		46	W
$I_{FSM}$	max. forward surge current	$t = 10$ ms; (50 Hz), sine	$T_{VJ} = 45^\circ\text{C}$			750	A
				$t = 8,3$ ms; (60 Hz), sine	$V_R = 0$ V		
		$t = 10$ ms; (50 Hz), sine	$T_{VJ} = 150^\circ\text{C}$				
				$t = 8,3$ ms; (60 Hz), sine	$V_R = 0$ V		
$I^2t$	value for fusing	$t = 10$ ms; (50 Hz), sine	$T_{VJ} = 45^\circ\text{C}$				
				$t = 8,3$ ms; (60 Hz), sine	$V_R = 0$ V		
		$t = 10$ ms; (50 Hz), sine	$T_{VJ} = 150^\circ\text{C}$				
				$t = 8,3$ ms; (60 Hz), sine	$V_R = 0$ V		
$C_J$	junction capacitance	$V_R = 400$ V; $f = 1$ MHz	$T_{VJ} = 25^\circ\text{C}$				10

Package PWS-B			Ratings			
Symbol	Definition	Conditions	min.	typ.	max.	Unit
$I_{RMS}$	RMS current	per terminal			100	A
$T_{stg}$	storage temperature		-40		125	°C
$T_{VJ}$	virtual junction temperature		-40		150	°C
<b>Weight</b>				203		g
$M_D$	mounting torque		4.25		5.75	Nm
$M_T$	terminal torque		2.5		3.5	Nm
$d_{Spp/App}$	creepage distance on surface   striking distance through air	terminal to terminal	11.0			mm
$d_{Spb/Appb}$		terminal to backside	7.5			mm
$V_{ISOL}$	isolation voltage	t = 1 second	3000			V
		t = 1 minute	2500			V



Ordering	Part Number	Marking on Product	Delivery Mode	Quantity	Code No.
Standard	VUO55-16NO7	VUO55-16NO7	Box	10	456691

### Equivalent Circuits for Simulation

\* on die level

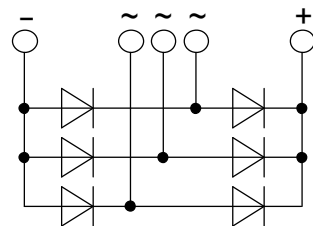
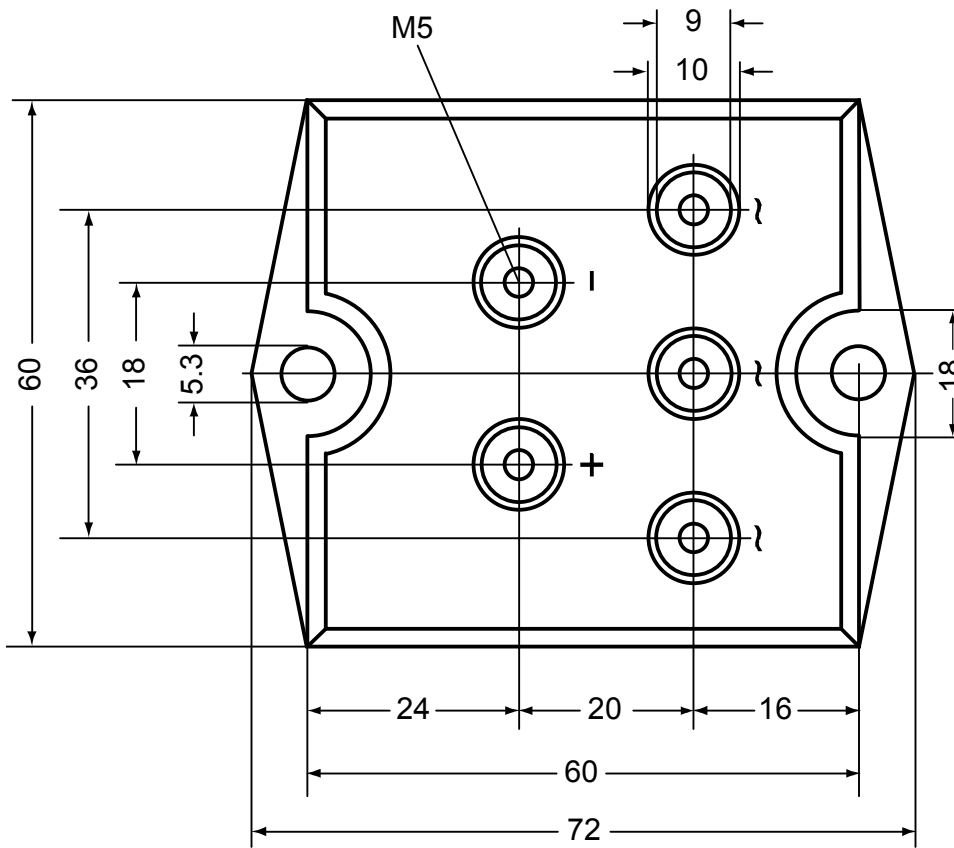
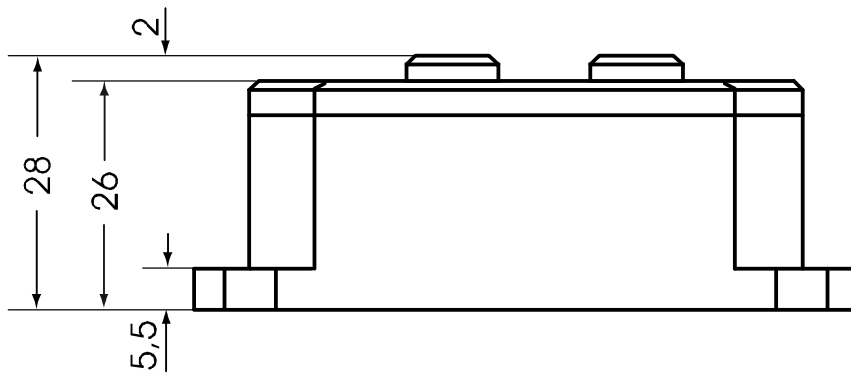
$T_{VJ} = 150\text{ °C}$



Rectifier

$V_{0\ max}$	threshold voltage	0.76	V
$R_{0\ max}$	slope resistance *	5.7	mΩ

**Outlines PWS-B**



## Rectifier

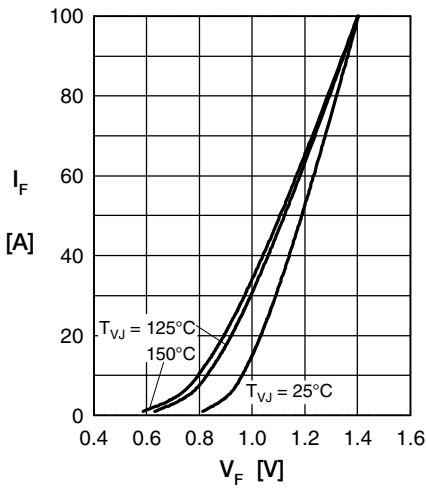


Fig. 1 Forward current vs. voltage drop per diode

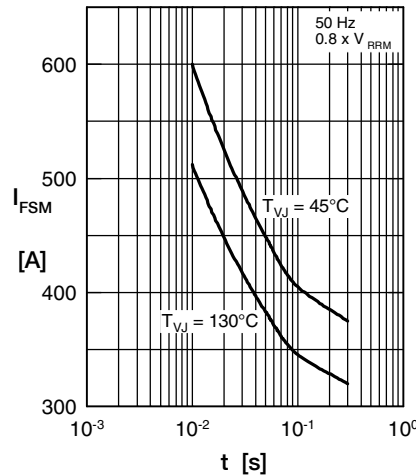


Fig. 2 Surge overload current vs. time per diode

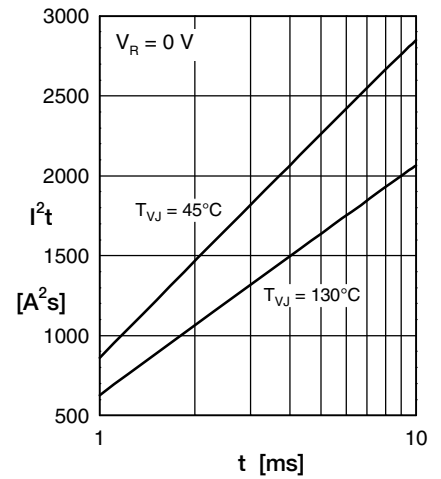


Fig. 3  $I^2t$  vs. time per diode

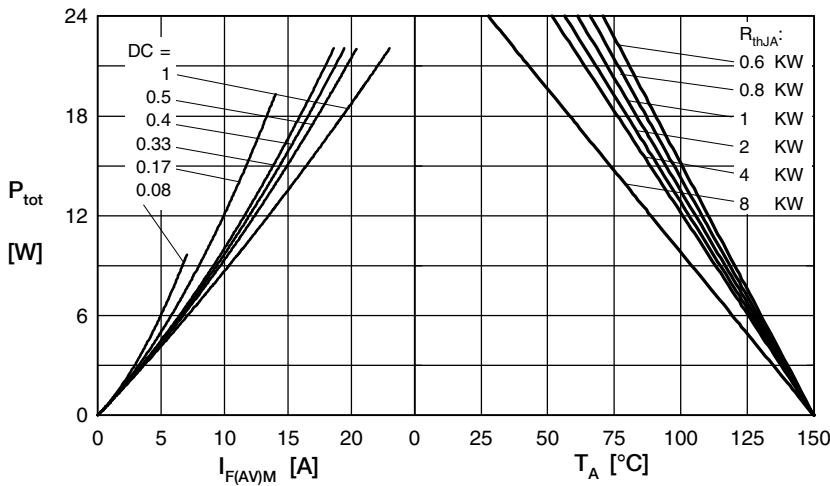


Fig. 4 Power dissipation vs. forward current and ambient temperature per diode

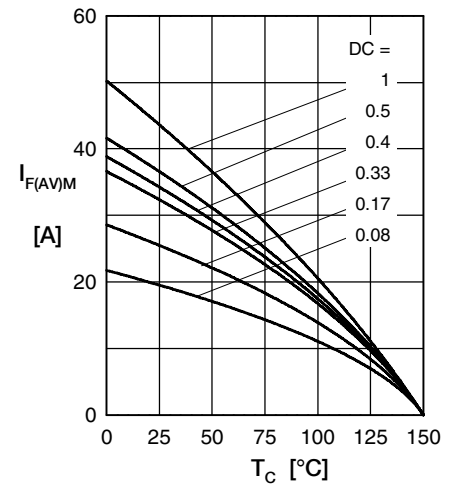


Fig. 5 Max. forward current vs. case temperature per diode

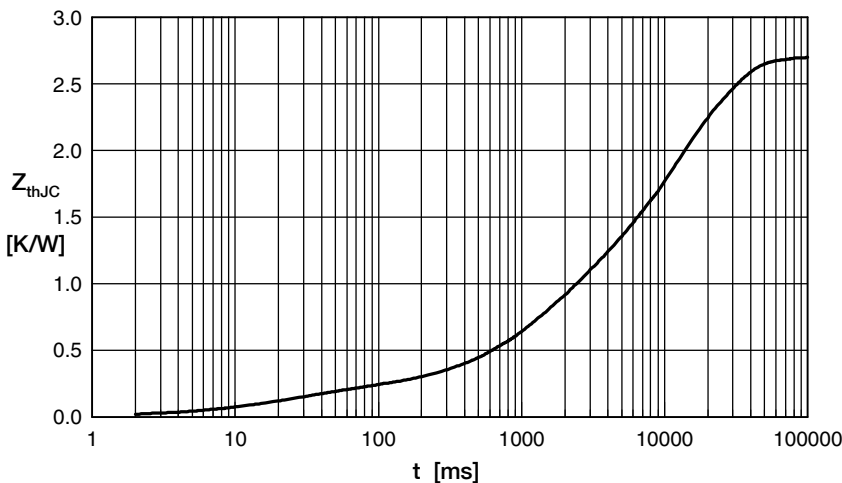


Fig. 6 Transient thermal impedance junction to case vs. time per diode

Constants for  $Z_{thJC}$  calculation:

i	$R_{th}$ (K/W)	$t_i$ (s)
1	0.040	0.010
2	0.150	0.030
3	0.610	1.350
4	1.900	14.00